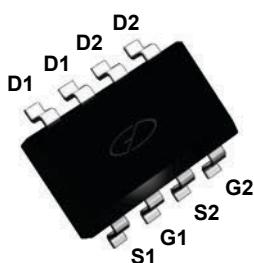
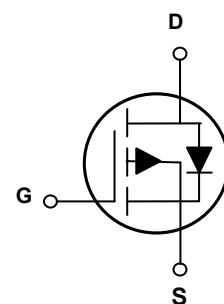


## Main Product Characteristics

|               |             |
|---------------|-------------|
| $V_{(BR)DSS}$ | -30V        |
| $R_{DS(ON)}$  | 25mΩ (Max.) |
| $I_D$         | -8A         |



SOP-8



Schematic Diagram

## Features and Benefits

- Advanced MOSFET process technology
- Ideal for high efficiency switched mode power supplies
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery



## Description

The GSFQ3025 utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supplies and a wide variety of other applications.

## Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$ unless otherwise specified)

| Parameter  | Symbol          | Max.        | Unit                      |
|--|-----------------|-------------|---------------------------|
| Drain-Source Voltage                                 | $V_{DS}$        | -30         | V                         |
| Gate-Source Voltage                                  | $V_{GS}$        | $\pm 20$    | V                         |
| Drain Current-Continuous ( $T_c=25^\circ\text{C}$ )  | $I_D$           | -8          | A                         |
| Drain Current-Continuous ( $T_c=100^\circ\text{C}$ ) |                 | -5.6        |                           |
| Drain Current-Pulsed <sup>1</sup>                    | $I_{DM}$        | -64         | A                         |
| Single Pulse Avalanche Energy <sup>2</sup>           | $E_{AS}$        | 95          | mJ                        |
| Single Pulse Avalanche Current <sup>2</sup>          | $I_{AS}$        | -19         | A                         |
| Power Dissipation ( $T_c=25^\circ\text{C}$ )         | $P_D$           | 3.2         | W                         |
| Power Dissipation-Derate above $25^\circ\text{C}$    |                 | 0.023       | W/ $^\circ\text{C}$       |
| Thermal Resistance, Junction-to-Ambient              | $R_{\theta JA}$ | 50          | $^\circ\text{C}/\text{W}$ |
| Thermal Resistance, Junction-to-Case                 | $R_{\theta JC}$ | 39          | $^\circ\text{C}/\text{W}$ |
| Operating Junction Temperature Range                 | $T_J$           | -55 To +150 | $^\circ\text{C}$          |
| Storage Temperature Range                            | $T_{STG}$       | -55 To +150 | $^\circ\text{C}$          |

**Electrical Characteristics** ( $T_J=25^\circ\text{C}$  unless otherwise specified)

| Parameter   | Symbol   | Conditions  | Min. | Typ.  | Max.      | Unit                       |
|---|--|---|------|-------|-----------|----------------------------|
| <b>On / Off Characteristics</b>                               |  |   |      |       |           |                            |
| Drain-Source Breakdown Voltage                                | $\text{BV}_{\text{DSS}}$                         | $V_{\text{GS}}=0\text{V}, I_{\text{D}}=-250\mu\text{A}$   | -30  | -     | -         | V                          |
| $\text{BV}_{\text{DSS}}$ Temperature Coefficient              | $\triangle \text{BV}_{\text{DSS}}/\triangle T_J$ | Reference to $25^\circ\text{C}$ , $I_{\text{D}}=-1\text{mA}$  | -    | -0.03 | -         | $\text{mV}/^\circ\text{C}$ |
| Drain-Source Leakage Current                                  | $I_{\text{DSS}}$                                 | $V_{\text{DS}}=-30\text{V}, V_{\text{GS}}=0\text{V}, T_J=25^\circ\text{C}$                                  | -    | -     | -1        | $\mu\text{A}$              |
|   |  | $V_{\text{DS}}=-24\text{V}, V_{\text{GS}}=0\text{V}, T_J=125^\circ\text{C}$                                 | -    | -     | -100      | $\mu\text{A}$              |
| Gate-Source Leakage Current                                   | $I_{\text{GSS}}$                                 | $V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$   | -    | -     | $\pm 100$ | nA                         |
| Static Drain-Source On-Resistance                             | $R_{\text{DS}(\text{ON})}$                       | $V_{\text{GS}}=-10\text{V}, I_{\text{D}}=-7.5\text{A}$  | -    | 20    | 25        | $\text{m}\Omega$           |
|   |  | $V_{\text{GS}}=-4.5\text{V}, I_{\text{D}}=-5\text{A}$   | -    | 32    | 39        |                            |
| Gate Threshold Voltage  | $V_{\text{GS}(\text{th})}$                       | $V_{\text{GS}}=V_{\text{DS}}, I_{\text{D}}=-250\mu\text{A}$   | -1.1 | -1.7  | -2.8      | V                          |
| $V_{\text{GS}(\text{th})}$ Temperature Coefficient            | $\triangle V_{\text{GS}(\text{th})}$             |   | -    | 4     | -         | $\text{mV}/^\circ\text{C}$ |
| Forward Transconductance                                      | $g_{\text{fs}}$                                  | $V_{\text{DS}}=-5\text{V}, I_{\text{D}}=-5\text{A}$   | -    | 20    | -         | S                          |
| <b>Dynamic and Switching Characteristics</b>                  |  |   |      |       |           |                            |
| Total Gate Charge <sup>2,3</sup>                              | $Q_g$  | $V_{\text{DS}}=-15\text{V}, I_{\text{D}}=-7.5\text{A}$<br>$V_{\text{GS}}=-10\text{V}$                       | -    | 21    | -         | $\text{nC}$                |
| Gate-Source Charge <sup>2,3</sup>                             | $Q_{\text{gs}}$                                  |   | -    | 1.4   | -         |                            |
| Gate-Drain Charge <sup>2,3</sup>                              | $Q_{\text{gd}}$                                  |   | -    | 4.2   | -         |                            |
| Turn-On Delay Time <sup>2,3</sup>                             | $t_{\text{d}(\text{on})}$                        | $V_{\text{DD}}=-15\text{V}, R_{\text{G}}=3\Omega$<br>$V_{\text{GS}}=-10\text{V}, I_{\text{D}}=-7.5\text{A}$ | -    | 12    | -         | $\text{nS}$                |
| Rise Time <sup>2,3</sup>                                      | $t_r$  |   | -    | 14    | -         |                            |
| Turn-Off Delay Time <sup>2,3</sup>                            | $t_{\text{d}(\text{off})}$                       |   | -    | 130   | -         |                            |
| Fall Time <sup>2,3</sup>                                      | $t_f$  |   | -    | 95    | -         |                            |
| Input Capacitance   | $C_{\text{iss}}$                                 | $V_{\text{DS}}=-15\text{V}, V_{\text{GS}}=0\text{V}, F=1\text{MHz}$   | -    | 1134  | -         | $\text{pF}$                |
| Output Capacitance  | $C_{\text{oss}}$                                 |   | -    | 184   | -         |                            |
| Reverse Transfer Capacitance                                  | $C_{\text{rss}}$                                 |   | -    | 117   | -         |                            |
| <b>Drain-Source Diode Characteristics and Maximum Ratings</b> |  |   |      |       |           |                            |
| Continuous Source Current                                     | $I_s$  | $V_G=V_D=0\text{V}$ , Force Current   | -    | -     | -8        | A                          |
| Pulsed Source Current   | $I_{\text{SM}}$                                  |   | -    | -     | -64       | A                          |
| Diode Forward Voltage   | $V_{\text{SD}}$                                  | $V_{\text{GS}}=0\text{V}, I_{\text{s}}=-3\text{A}, T_J=25^\circ\text{C}$                                    | -    | -     | -1        | V                          |
| Reverse Recovery Time   | $t_{\text{rr}}$                                  | $I_F=-7\text{A}$ , $dI/dt=-100\text{A}/\mu\text{s}$   | -    | 36    | -8        | ns                         |
| Reverse Recovery Charge                                       | $Q_{\text{rr}}$                                  |   | -    | 34    | -64       | nC                         |

Notes:

1. Repetitive rating: Pulsed width limited by maximum junction temperature.
2.  $V_{\text{DD}}=-25\text{V}, V_{\text{GS}}=-10\text{V}, L=0.5\text{mH}, R_{\text{G}}=25\Omega$ , starting  $T_J=25^\circ\text{C}$ .
3. Pulse test: pulse width  $\leq 300\text{us}$ , duty cycle  $\leq 2\%$ .

### Typical Electrical and Thermal Characteristic Curves

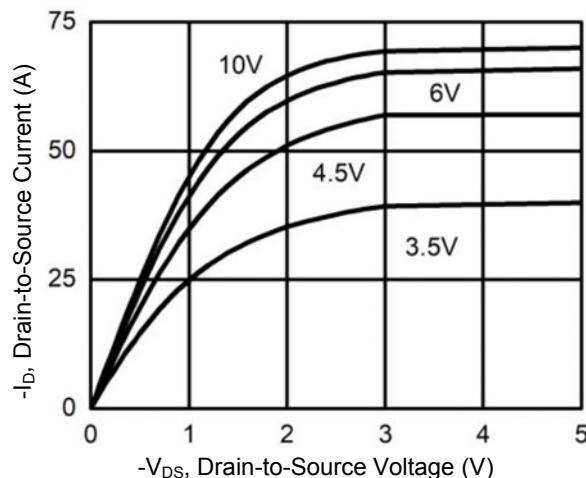


Figure 1. Output Characteristics

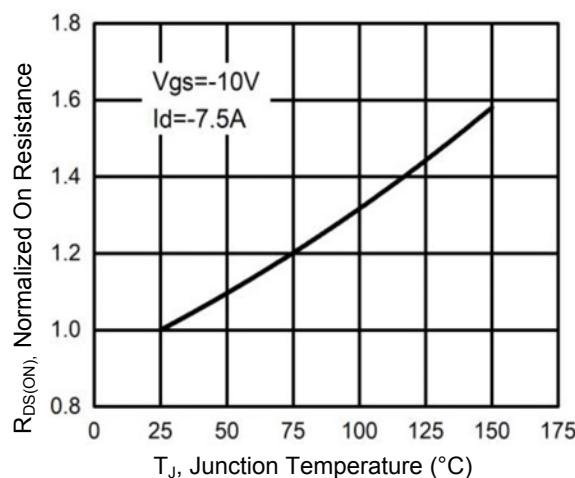


Figure 2. Normalized  $R_{DS(ON)}$  vs.  $T_J$

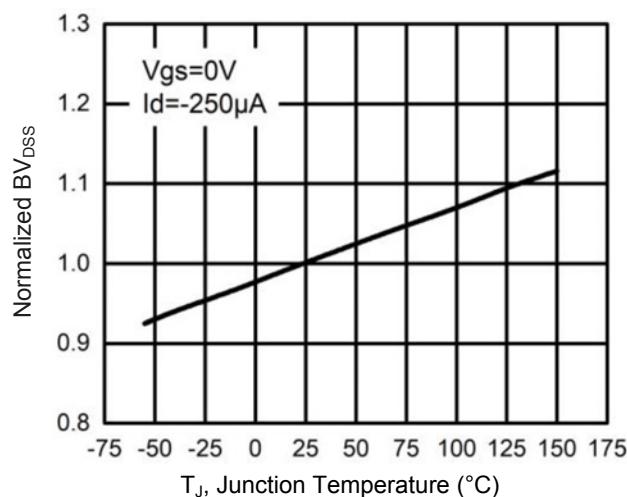


Figure 3. Normalized  $BV_{DSS}$  vs.  $T_J$

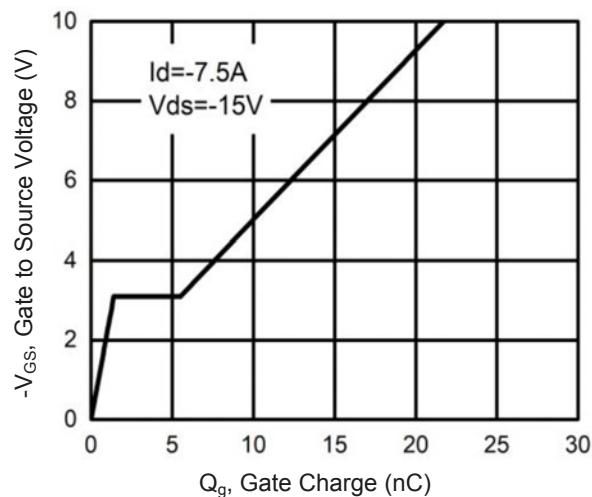


Figure 4. Gate Charge Waveform

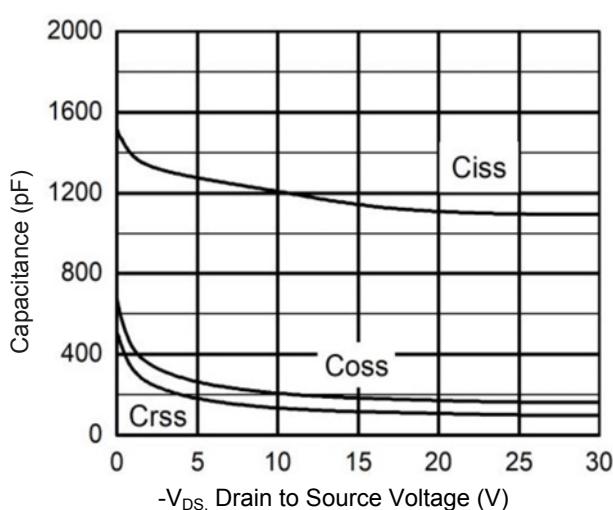


Figure 5. Capacitance Characteristics

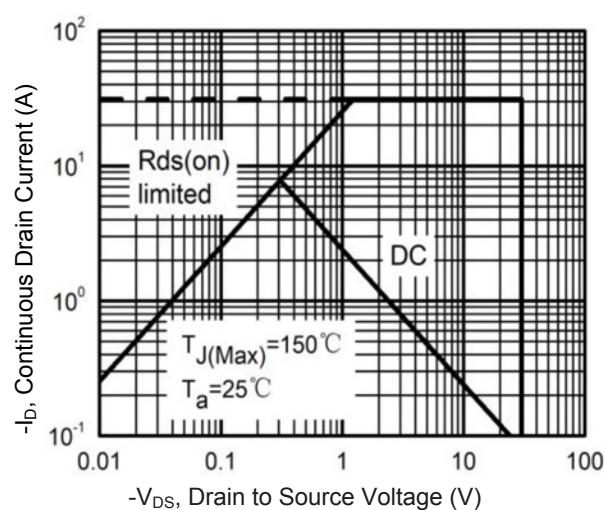
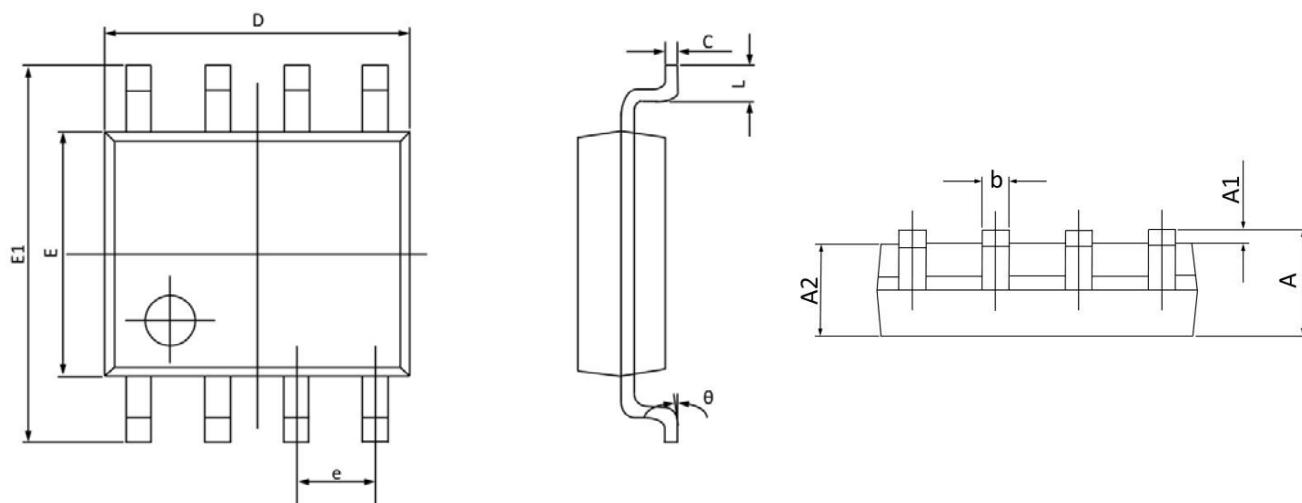


Figure 6. Safe Operation Area

### Package Outline Dimensions (SOP-8)



| Symbol | Dimensions In Millimeters |       | Dimensions In Inches |       |
|--------|---------------------------|-------|----------------------|-------|
|        | Min                       | Max   | Min                  | Max   |
| A      | 1.350                     | 1.750 | 0.053                | 0.069 |
| A1     | 0.100                     | 0.250 | 0.004                | 0.010 |
| A2     | 1.300                     | 1.500 | 0.051                | 0.059 |
| b      | 0.350                     | 0.490 | 0.014                | 0.019 |
| C      | 0.190                     | 0.260 | 0.007                | 0.010 |
| D      | 4.700                     | 5.100 | 0.185                | 0.201 |
| E      | 3.700                     | 4.100 | 0.146                | 0.161 |
| E1     | 5.800                     | 6.200 | 0.228                | 0.244 |
| e      | 1.270 BSC                 |       | 0.050 BSC            |       |
| L      | 0.400                     | 0.900 | 0.016                | 0.035 |
| θ      | 0°                        | 8°    | 0°                   | 8°    |

### Order Information

| Device   | Package | Marking | Quantity        | Carrier     |
|----------|---------|---------|-----------------|-------------|
| GSFQ3025 | SOP-8   | Q3025   | 3,000pcs / Reel | Tape & Reel |